

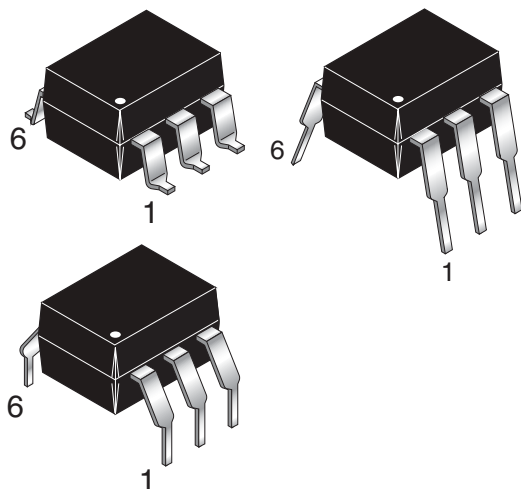
SL5500

SL5501

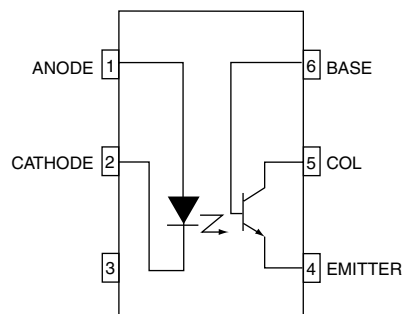
SL5504

SL5511

PACKAGE



SCHEMATIC



DESCRIPTION

The SL5500, SL5501, SL5504 and SL5511 are optically coupled isolators each consisting of an infrared emitting GaAs diode and a silicon NPN phototransistor with accessible base. These devices are housed in 6-pin dual-in-line packages (DIP).

FEATURES

- High output/input DC current transfer ratio
- Low saturation voltage
- High isolation voltage of 5.3 kV RMS
- UL recognized (File # E90700)
- VDE recognized (File # 94766)
- Ordering option '300' (e.g. SL5500.300)

APPLICATIONS

- Power supply regulators
- Digital logic inputs
- Microprocessor inputs
- Appliance sensor systems
- Industrial controls

SL5500

SL5501

SL5504

SL5511

Parameters		Symbol	Value	Units
TOTAL DEVICE				
Storage Temperature		T _{STG}	-55 to +150	°C
Operating Temperature		T _{OPR}	-55 to +100	°C
Lead Solder Temperature		T _{SOL}	260 for 10 sec	°C
Total Power Dissipation at T _A = 25°C Ambient Derate Linearly from 25°C		P _D	260	mW
			3.3	mW/°C
EMITTER				
Continuous Reverse Voltage		V _R	3	V
Continuous Forward Current		I _F	100	mA
Forward Current - Peak (10 μs pulse, δ = 0.01)		I _{F(pk)}	3.0	A
Total Power Dissipation T _A = 25°C Ambient Derate Linearly from 25°C		P _D	150	mW
			2.0	mW/°C
DETECTOR				
Collector to Emitter Voltage (open base)	SL5500, SL5501, SL5511	V _{CEO}	30	V
	SL5504		80	
Collector to Base Voltage (open emitter)	SL5500, SL5501, SL5511	V _{CBO}	70	V
	SL5504		120	
Emitter to Collector Voltage (open base)		V _{ECO}	7	V
Emitter to Base Voltage (open collector)		V _{EBO}	7	V
DC Collector Current		I _C	100	mA
Detector Power Dissipation @ T _A = 25°C Ambient Derate Linearly from 25°C		P _D	150	mW
			2.0	mW/°C

SL5500

SL5501

SL5504

SL5511

ELECTRICAL CHARACTERISTICS ($T_A = 25^\circ\text{C}$ Unless otherwise specified.)

INDIVIDUAL COMPONENT CHARACTERISTICS

Parameters	Test Conditions	Symbol	Device	Min	Typ*	Max	Units
EMITTER							
Input Forward Voltage	$I_F = 20\text{ mA}$, $T_A = 25\text{ to }70^\circ\text{C}$	V_F	All		1.23	1.3	V
	$I_F = 2\text{ mA}$				1.10	1.2	V
Reverse Current	$V_R = 3\text{ V}$, $T_A = 25\text{ to }70^\circ\text{C}$	I_R	All		0.001	10	μA
DETECTOR							
Leakage Current Collector to Emitter	$V_{CE} = 10\text{ V}$	I_{CEO}	All		1	50	nA
	$V_{CE} = 30\text{ V}$				0.005	10	μA
	$V_{CE} = 10\text{ V}$, $T_A = 70^\circ\text{C}$					500	nA
	$V_{CB} = 30\text{ V}$	I_{CBO}			0.001	50	μA
Breakdown Voltage							
Collector to Emitter	$I_C = 10\text{ }\mu\text{A}$, $I_F = 0$	BV_{CEO}	SL5500, SL5501, SL5511	30	100		V
			SL5504	80	110		
Collector to Base	$I_C = 10\text{ }\mu\text{A}$, $I_F = 0$	BV_{CBO}	SL5500, SL5501, SL5511	30	120		V
			SL5504	120	150		
Emitter to Collector	$I_E = 10\text{ }\mu\text{A}$, $I_F = 0$	BV_{ECO}	All	7	10		V
Emitter to Base	$I_E = 10\text{ }\mu\text{A}$, $I_F = 0$	BV_{EBO}	All	7	10		V

ISOLATION CHARACTERISTICS

Characteristic	Test Conditions	Symbol	Min	Typ*	Max	Units
Input-Output Isolation Voltage (note 1)	$f = 60\text{ Hz}$, $T = 1\text{ min.}$	V_{ISO}	5300			$V_{AC(RMS)}$
Isolation Resistance	$V_{I-O} = \pm 500\text{ VDC}$	R_{ISO}	1	10		$T\Omega$
Isolation Capacitance	$f = 1\text{ MHz}$, $V = 0\text{ V}$	C_{ISO}		0.6	1.3	pF

*Typical values at $T_A = 25^\circ\text{C}$

SL5500

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TRANSFER CHARACTERISTICS (TA = 25°C Unless otherwise specified.)

DC Characteristics	Test Conditions	Symbol	Device	Min	Typ	Max	Units
Output/Input Current Transfer Ratio	$I_F = 10 \text{ mA}, V_{CE} = 0.4 \text{ V}$	CTR	SL5500	50		300	%
	$I_F = 10 \text{ mA}, V_{CE} = 0.4 \text{ V}, T_A = 70^\circ\text{C}$		SL5500	40		300	
	$I_F = 10 \text{ mA}, V_{CE} = 0.4 \text{ V}, T_A = 25^\circ\text{C to } 70^\circ\text{C}$		SL5501, SL5504	25		400	
	$I_F = 2 \text{ mA}, V_{CE} = 5 \text{ V}$		SL5500	40			
	$I_F = 2 \text{ mA}, V_{CE} = 5 \text{ V}, T_A = 70^\circ\text{C}$		SL5500	30			
	$I_F = 2 \text{ mA}, V_{CE} = 5 \text{ V}, T_A = 25^\circ\text{C to } 70^\circ\text{C}$		SL5501, SL5504	15			
	$I_F = 2 \text{ mA}, V_{CE} = 5 \text{ V}, T_A = 25^\circ\text{C to } 70^\circ\text{C}$		SL5511	25			
	$I_F = 0.5 \text{ mA}, V_{CE} = 0.4 \text{ V}, T_A = 25^\circ\text{C to } 70^\circ\text{C}$		SL5511	20			
Collector-Emitter Saturation Voltage	$I_F = 50 \text{ mA}, I_C = 10 \text{ mA}$	$V_{CE(SAT)}$	SL5500			0.4	V
	$I_F = 20 \text{ mA}, I_C = 2 \text{ mA}$		SL5501, SL5504, SL5511			0.4	
AC Characteristics	Test Conditions	Symbol	Device	Min	Typ	Max	Units
Turn-On Time	$R_L = 1 \text{ k}\Omega, I_F = 16 \text{ mA}, V_{CC} = 5 \text{ V}$	t_{on}	SL5500, SL5501, SL5511			20	μs
			SL5504			50	
Turn-Off Time	See Fig. 1 and Fig. 2	t_{off}	SL5500, SL5501, SL5511			50	μs
			SL5504			150	

Note

1. Device considered a two-terminal device: pins 1, 2 and 3 shorted together and pins 4, 5 and 6 shorted together.

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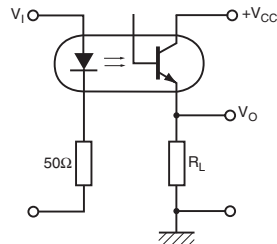


Fig. 1 Switching Circuit

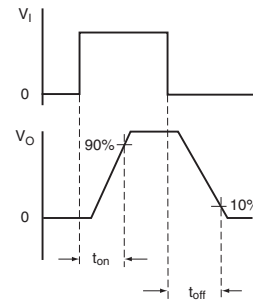


Fig. 2 Waveforms

Fig. 3 LED Forward Voltage vs. Forward Current

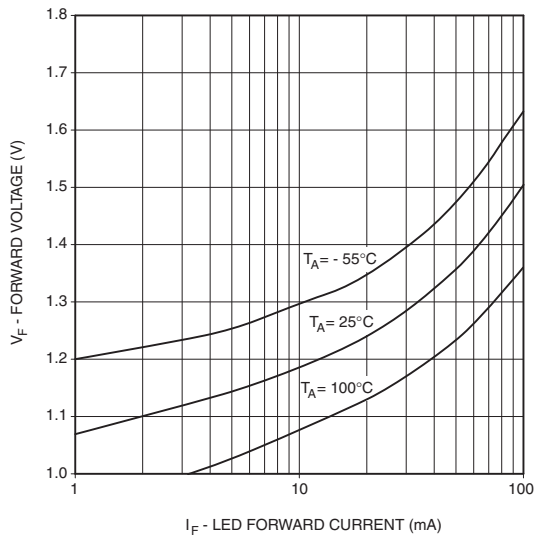


Fig. 4 Normalized CTR vs. Forward Current

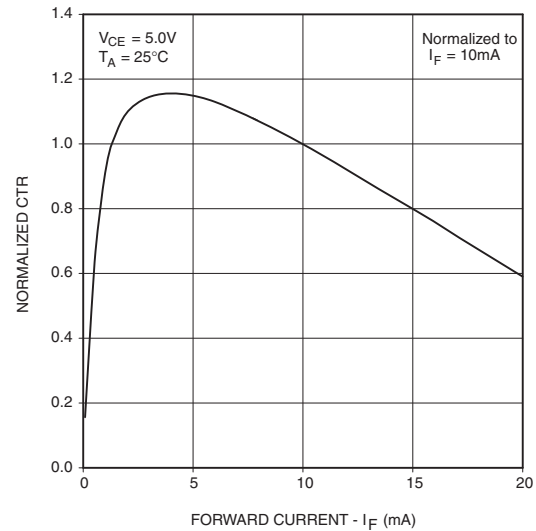


Fig. 5 Normalized CTR vs. Ambient Temperature

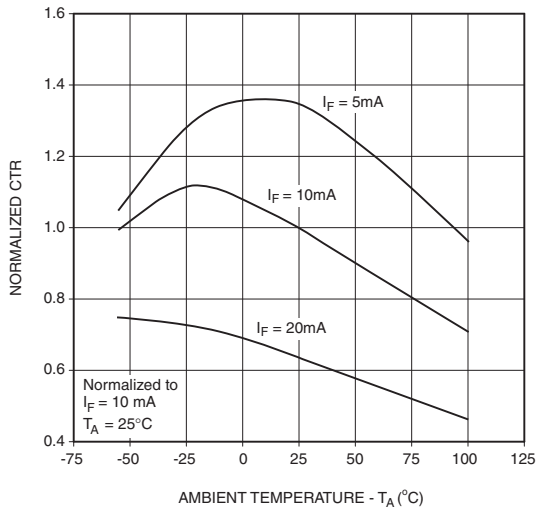
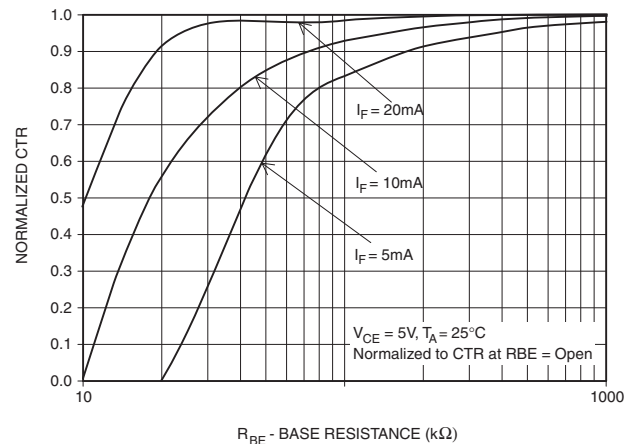


Fig. 7 CTR vs. R_BE (Unsaturated)



SL5500

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SL5511

Fig. 7 CTR vs. R_{BE} (Saturated)

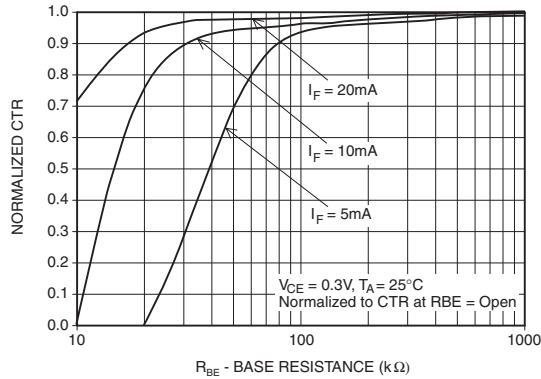


Fig. 8 Normalized t_{off} vs. R_{BE}

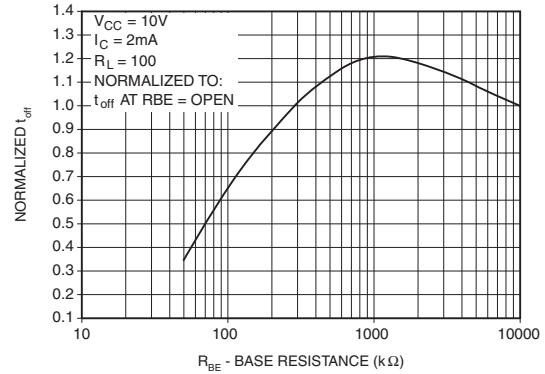


Fig. 9 Normalized t_{on} vs. R_{BE}

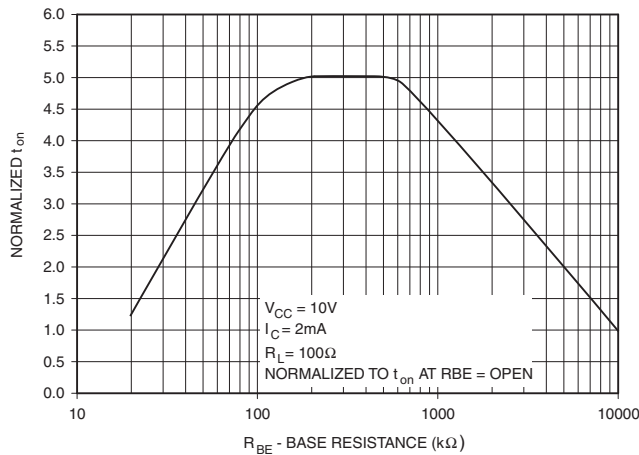


Fig. 10 Switching Speed vs. Load Resistor

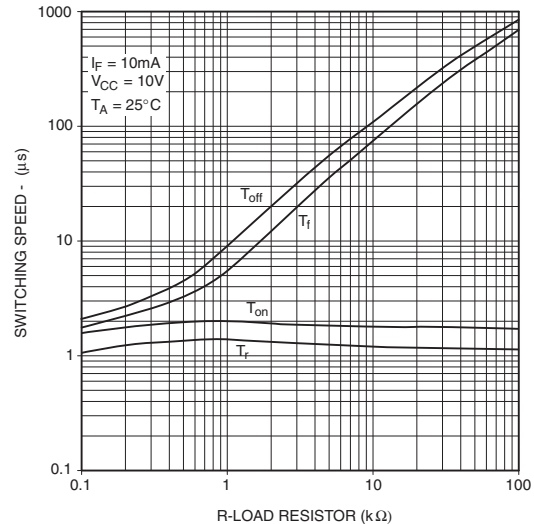


Fig. 11 Collector Emitter Saturation Voltage vs. Collector Current

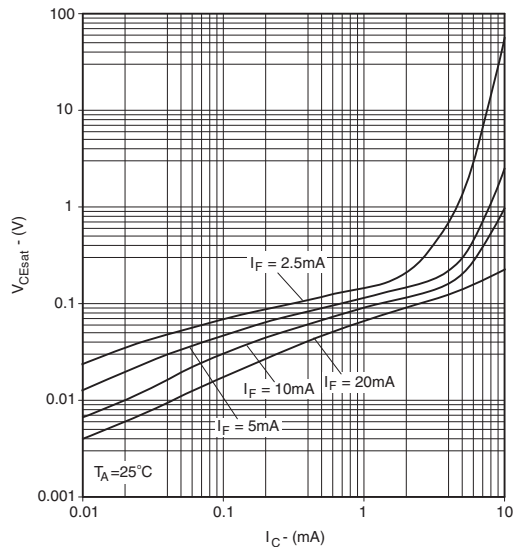
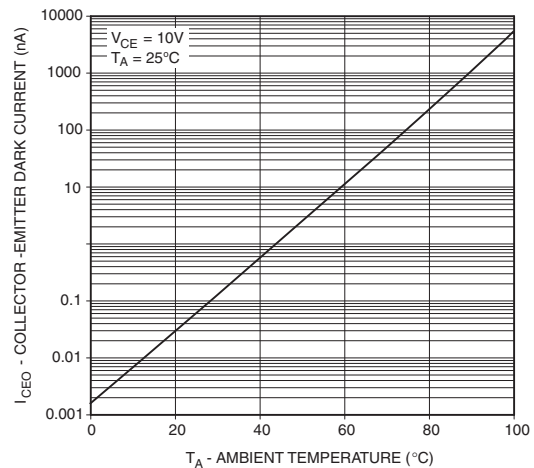


Fig. 12 Dark Current vs. Ambient Temperature



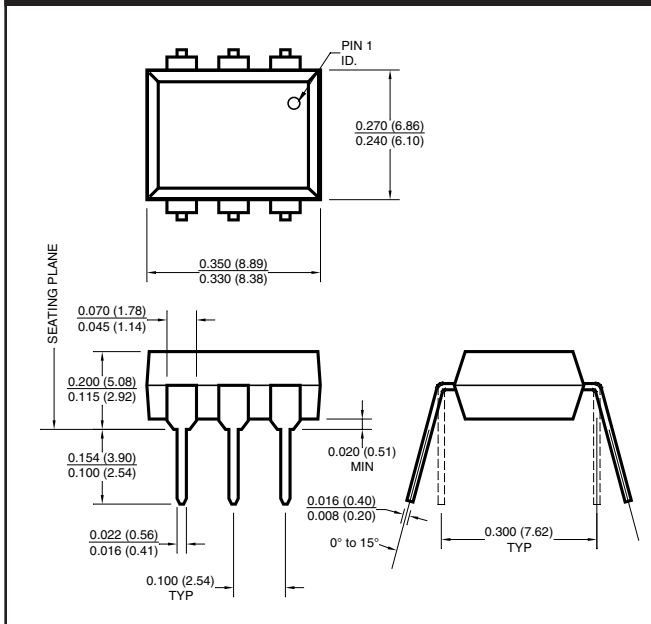
SL5500

SL5501

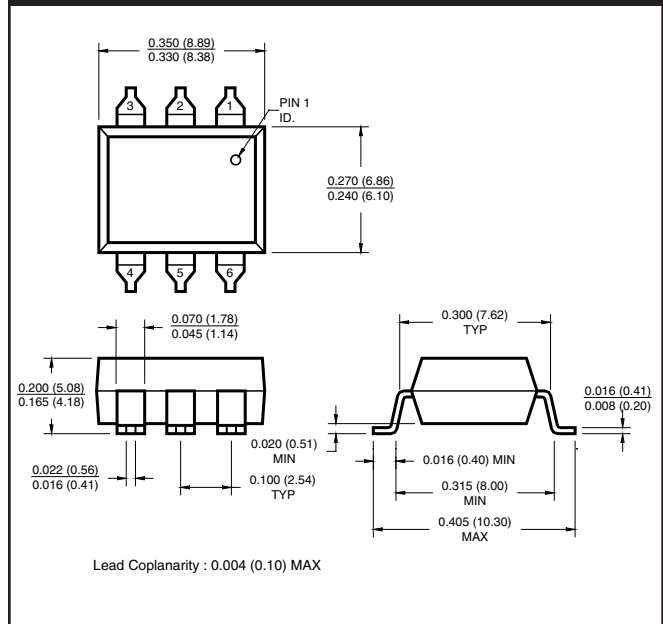
SL5504

SL5511

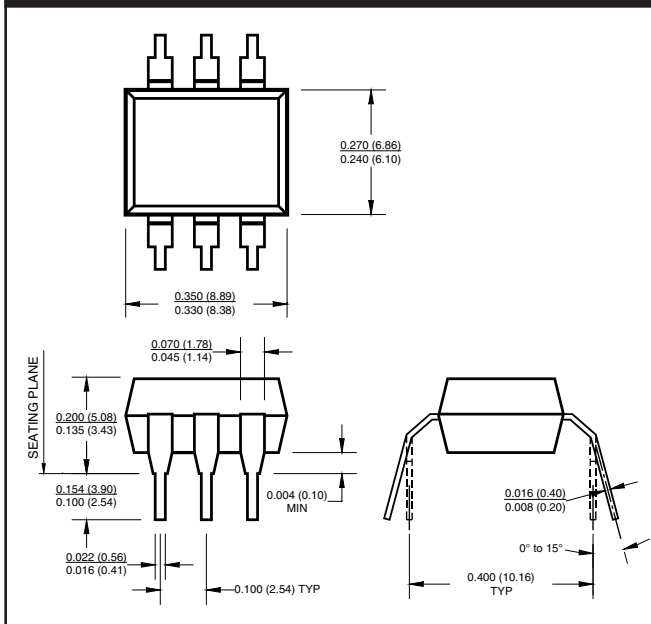
Package Dimensions (Through Hole)



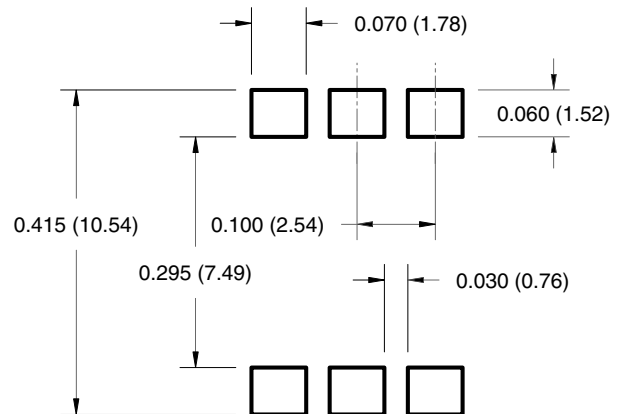
Package Dimensions (Surface Mount)



Package Dimensions (0.4" Lead Spacing)



Recommended Pad Layout for Surface Mount Leadform



Note

All dimensions are in inches (millimeters)

SL5500

SL5501

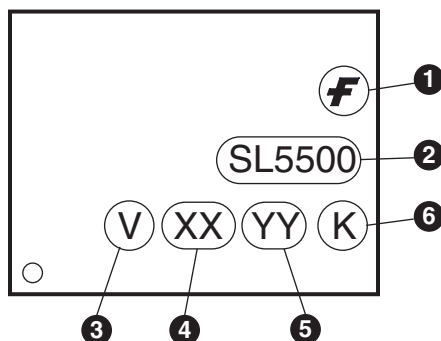
SL5504

SL5511

ORDERING INFORMATION

Option	Order Entry Identifier	Description
S	.S	Surface Mount Lead Bend
SD	.SD	Surface Mount; Tape and Reel
W	.W	0.4" Lead Spacing
300	.300	VDE 0884
300W	.300W	VDE 0884, 0.4" Lead Spacing
3S	.3S	VDE 0884, Surface Mount
3SD	.3SD	VDE 0884, Surface Mount, Tape and Reel

MARKING INFORMATION



Definitions	
1	Fairchild logo
2	Device number
3	VDE mark (Note: Only appears on parts ordered with VDE option – See order entry table)
4	Two digit year code, e.g., '03'
5	Two digit work week ranging from '01' to '53'
6	Assembly package code

Technical drawing of a 5-axis lathe tool holder. The drawing shows a side view of the tool holder with various dimensions and features. The dimensions are in millimeters (mm).

Dimensions and features:

- Overall length: 12.0 ± 0.1
- Distance from left face to first hole: 4.85 ± 0.20
- Distance between holes: 4.0 ± 0.1
- Distance from last hole to right face: 4.0 ± 0.1
- Overall width: 16.0 ± 0.3
- Distance from top face to hole center: 7.5 ± 0.1
- Distance from bottom face to hole center: 9.55 ± 0.20
- Hole diameter: $\varnothing 1.55 \pm 0.05$
- Distance from left face to tool holder body: 0.30 ± 0.05
- Distance from tool holder body to right face: 10.30 ± 0.20
- Distance from tool holder body to hole center: 13.2 ± 0.2
- Distance from tool holder body to hole center: 0.1 MAX
- Distance from tool holder body to hole center: 0.16 ± 0.1
- User Direction of Feed: Indicated by an arrow pointing to the right.

All dimensions are in inches (millimeters)

The graph plots Temperature (°C) on the y-axis (0 to 300) against Time (Minute) on the x-axis (0 to 4.5). The curve shows a linear ramp up from 0°C at 0 minutes to 225°C at 2.5 minutes, labeled "Ramp up = 3C/sec". After 2.5 minutes, the temperature levels off and then rises to a peak of 215°C at 3.5 minutes, labeled "215°C, 10-30 s". The time interval above 183°C is indicated as 60-150 seconds, labeled "Time above 183°C, 60-150 sec". The temperature then decreases after the peak.

- Peak reflow temperature: 225°C (package surface temperature)
- Time of temperature higher than 183°C for 60–150 seconds
- One time soldering reflow is recommended

SL5500

SL5501

SL5504

SL5511

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